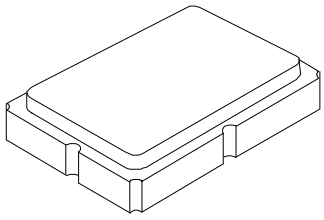
RFM
A BRAND OF AKOUSTIS

RoHS compliant

RO3104A-1

303.825 MHz SAW Resonator

- ***Ideal for 303.825 MHz Transmitters***
- ***Very Low Series Resistance***
- ***Quartz Stability***
- ***Surface-Mount, Ceramic Case***
- ***Complies with Directive 2002/95/EC (RoHS)***
- ***Tape and Reel Standard per ANSI/EIA-481***
- ***Moisture Sensitivity Level: 1***
- ***AEC-Q200 Qualified***



SM5035-4 Case

The RO3104A-1 is a true one-port, surface-acoustic-wave (SAW) resonator in a surface-mount, ceramic case. It provides reliable, fundamental-mode, quartz frequency stabilization of fixed-frequency transmitters operating at 303.825 MHz. This SAW is designed specifically for AM transmitters in wireless security and remote control applications operating in the USA under FCC Part 15, in Australia, in Japan, and in Korea

Absolute Maximum Ratings

Rating	Value	Units
CW RF Power Dissipation (See Typical Test Circuit)	0	dBm
DC Voltage Between Terminals (Observe ESD Precautions)	±30	VDC
Case Temperature	-40 to +85	°C
Soldering Temperature (10 seconds / 5 cycles max.)	260	°C

Characteristic		Sym	Notes	Minimum	Typical	Maximum	Units
Frequency (+25 °C)	Nominal Frequency	f_C		303.775		303.875	MHz
	Tolerance from 303.825 MHz	Δf_C				±50	kHz
Insertion Loss		IL			1.5	2.0	dB
Quality Factor	Unloaded Q	Q_U			9700		
	50 Ω Loaded Q	Q_L			1500		
Temperature Stability	Turnover Temperature	T_O		10	25	40	°C
	Turnover Frequency	f_O			f_C		
	Frequency Temperature Coefficient	FTC			0.032		ppm/°C^2
Frequency Aging	Absolute Value during the First Year	$\|f_A\|$			10		ppm/yr
DC Insulation Resistance between Any Two Terminals				1.0			MΩ
RF Equivalent RLC Model	Motional Resistance	R_M			18.7		Ω
	Motional Inductance	L_M			95.3		µH
	Motional Capacitance	C_M			2.88		fF
	Transducer Static Capacitance	C_O			3.3		pF
Test Fixture Shunt Inductance		L_{TEST}			83.1		nH
Lid Symbolization: YY = Year, WW = Week, S = Shift)		755, YYWWS					

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

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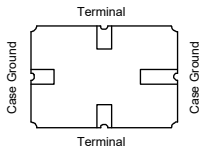
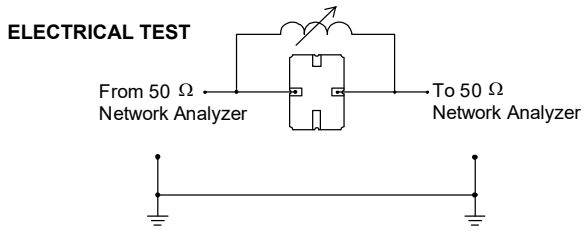
Electrical Connections

The SAW resonator is bidirectional and may be installed with either orientation. The two terminals are interchangeable and unnumbered. The callout NC indicates no internal connection. The NC pads assist with mechanical positioning and stability. External grounding of the NC pads is recommended to help reduce parasitic capacitance in the circuit.

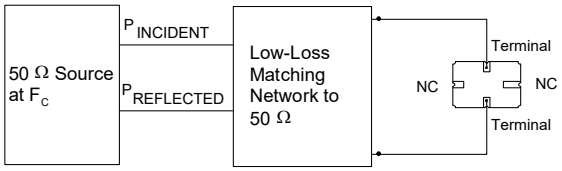


Typical Test Circuit

The test circuit inductor, L_{TEST}, is tuned to resonate with the static capacitance, C_O, at F_C.



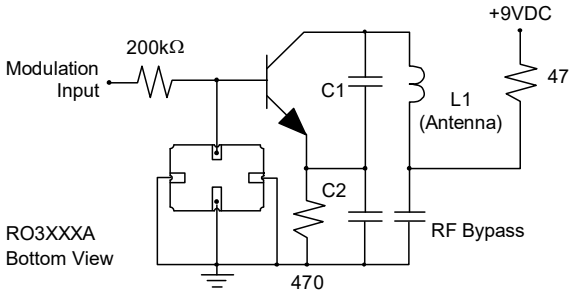
POWER TEST



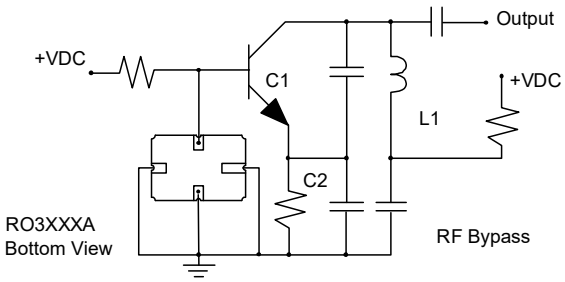
CW RF Power Dissipation = $P_{INCIDENT} - P_{REFLECTED}$

Typical Application Circuits

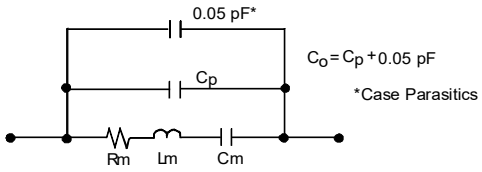
Typical Low-Power Transmitter Application



Typical Local Oscillator Applications

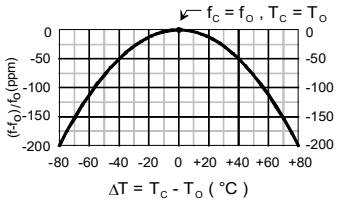


Equivalent LC Model



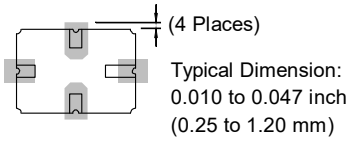
Temperature Characteristics

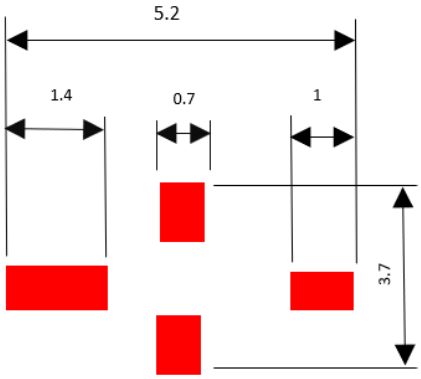
The curve shown on the right accounts for resonator contribution only and does not include LC component temperature contributions.



Typical Circuit Board Land Pattern

The circuit board land pattern shown below is one possible design. The optimum land pattern is dependent on the circuit board assembly process which varies by manufacturer. The distance between adjacent land edges should be at a maximum to minimize parasitic capacitance. Trace lengths from terminal lands to other components should be short and wide to minimize parasitic series inductances.





PCB Footprint

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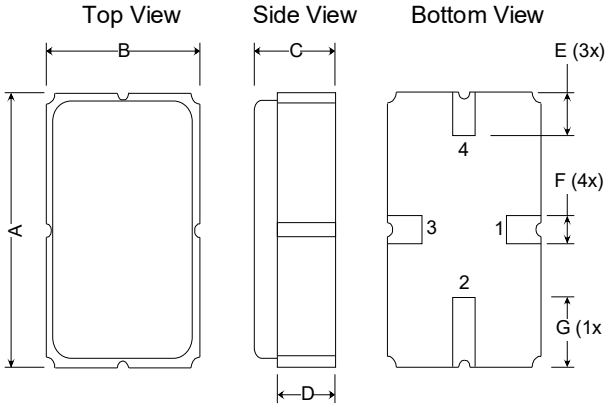
Case Design



Dimensions	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	4.87	5.0	5.13	.191	.196	.201
B	3.37	3.5	3.63	.132	.137	.142
C	1.45	1.53	1.60	.057	.060	.062
D	1.35	1.43	1.50	.040	.057	.059
E	.67	.80	.93	.026	.031	.036
F	.37	.50	.63	.014	.019	.024
G	1.07	1.20	1.33	.042	.047	.052

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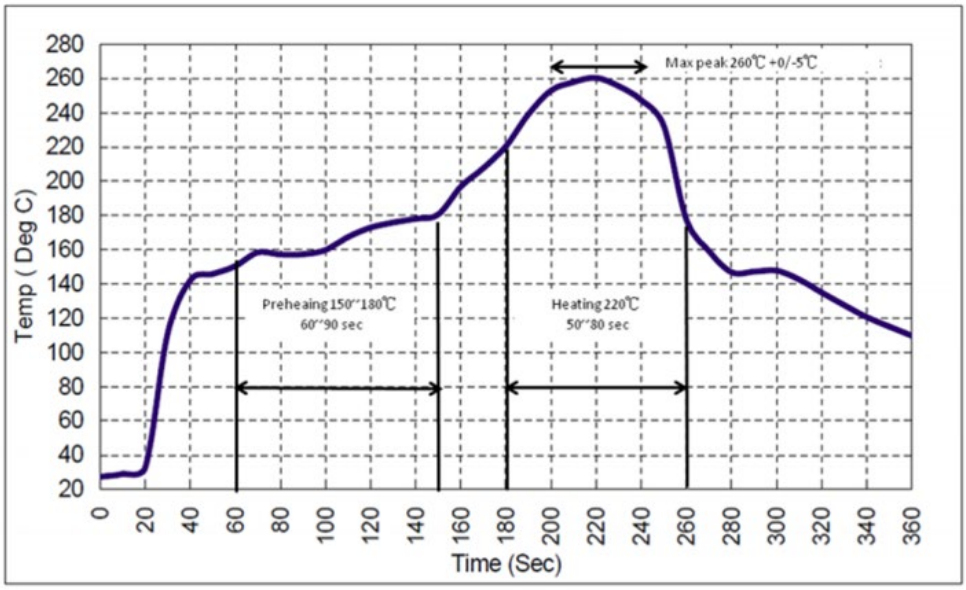
Recommended Reflow Profile

1. Preheating shall be fixed at 150~180ºC for 60~90 seconds.
2. Ascending time to preheating temperature 150ºC shall be 30 seconds min.
3. Heating shall be fixed at 220ºC for 50~80 seconds and at 260ºC +0/-5ºC peak (10 seconds).
4. Time: 5 times maximum.



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